



1374.45693X00

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THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: C. MIYAZAKI, et al.
Serial No: 10/562,800
Filed: DECEMBER 29, 2005
Title: MANUFACTURING METHOD OF SEMICONDUCTOR
INTEGRATED CIRCUIT DEVICE
Group AU: TBA
Examiner: 2812
Confirm. No: 8700

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 AND 1.98**

Mail Stop: AMEND – NO FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

May 29, 2008

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action in connection with a corresponding Chinese application, together with an English translation thereof. Also enclosed are copies of documents cited in the enclosed Official Action, and English-language abstracts and/or machine-generated English translations and/or corresponding English-language patent documents, of these cited documents. Further enclosed is a Form PTO/SB/08A, listing the enclosed documents.

This Information Disclosure Statement is being submitted prior to a first Office Action on the merits in the above-identified application. Accordingly, requirements of 37 CFR 1.97(b) are satisfied.

In any event, the following Statement is made under 37 CFR 1.97(e):

Each item of information contained in this
Information Disclosure Statement was first cited in
any communication from a foreign patent office in a

counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

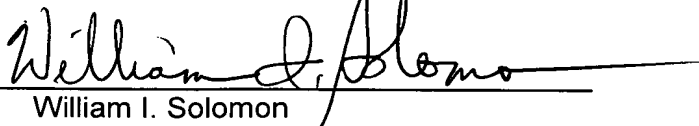
To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by respective machine-generated English translations and/or English-language abstracts and/or corresponding English-language patent documents, also submitted herewith, and/or discussion of the documents in the English translation of the enclosed Official Action.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with present submission of the enclosed documents. Accordingly, consideration of the enclosed documents, upon examination of the above-identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case No. 1374.45693X00), or credit any excess fees paid to such Deposit Account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

By 
William I. Solomon
Registration No. 28,565

WIS/ksh
1300 N. Seventeenth Street
Suite 1800
Arlington, Virginia 22209
Tel: 703-312-6600
Fax: 703-312-6666